

Part Number: XGCBDX20D

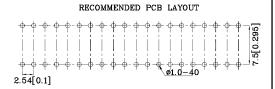
 $20 \; {
m SEGMENTS} \; {
m BAR} \; {
m GRAPH} \; {
m ARRAY}$

Features

- Robust package
- Uniform light disbursement
- Ideal for backlighting logos or icons
- Excellent for flush mounting
- Standard configuration: Gray face w/ white segments
- RoHS Compliant





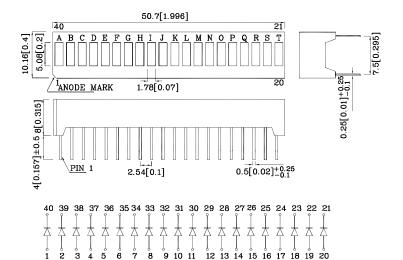




ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Schematics



Votes.

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01") \text{unless}$ otherwise noted.

2. Specifications are subject to change without notice.

| Absolute Maximum Ratings (T _A =25°C) | | CBD (InGaN) | Unit | |
|--|-----------------------|----------------|------|--|
| Reverse Voltage | $V_{\rm R}$ | 5 | V | |
| Forward Current | I_{F} | 30 | mA | |
| Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width | ifs | 150 | mA | |
| Power Dissipation | P_{D} | 120 | mW | |
| Operating Temperature | $T_{\rm A}$ | -40 ~ +85 | °C | |
| Storage Temperature | Tstg | -40 ~ +85 | | |
| Electrostatic Discharge Threshold (HBM) | | 250 | V | |
| Lead Solder Temperature [2mm Below Package Base] | 260°C For 3-5 Seconds | | | |

| Operating Characteristics (T _A =25°C) | | CBD (InGaN) | Unit |
|--|---------------------|----------------|------|
| Forward Voltage (Typ.) (I _F =10mA) | V_{F} | 3 | V |
| Forward Voltage (Max.) (I _F =10mA) | V_{F} | 4 | V |
| Reverse Current (Max.) (V _R =5V) | I_{R} | 50 | uA |
| Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA) | yp.) λP 460 | | nm |
| Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA) | λD | 465* | nm |
| Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA) | $\triangle \lambda$ | 25 | nm |
| Capacitance (Typ.) (V _F =0V, f=1MHz) | С | 100 | pF |

| Part Number | Emitting Color | Emitting Material | Luminous Intensity CIE127-2007* $(I_F=10\text{mA})$ ucd | | Wavelength CIE127-2007* nm λP | Description |
|----------------|-------------------|----------------------|---|-------|-------------------------------------|----------------------------------|
| | | | min. | typ. | | |
| XGCBDX20D | Blue | InGaN | 3600* | 9390* | 460* | 20 Segments Bar graph-Display |

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007

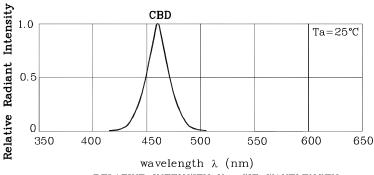
Mar 05,2014

XDSB4450 V4-Z Layout: Maggie L.



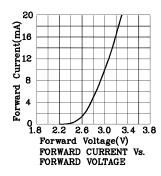


20 SEGMENTS BAR GRAPH ARRAY

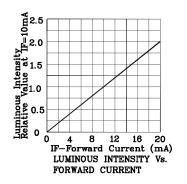


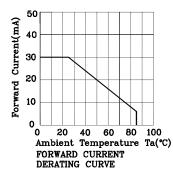
RELATIVE INTENSITY Vs. CIE WAVELENGTH

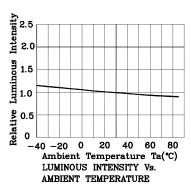
♦ CBD



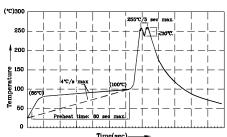
www.SunLEDusa.com







Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- nmend pre-heat temperature of 105°C or less (as measured with a noccouple attached to the LED pins) prior to immersion in the solder with a maximum solder bath temperature of 250°C wave soldering temperature between 245°C \sim 255°C for 3 sec (5 sec
- 2.Peak wave soldering temperature oetwermax).
 3.Do not apply stress to the epoxy resin (-Pixtures should not incur stress on the during soldering process.
 5.SAC 305 solder alloy is recommended.
 6.No more than one wave soldering pass.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

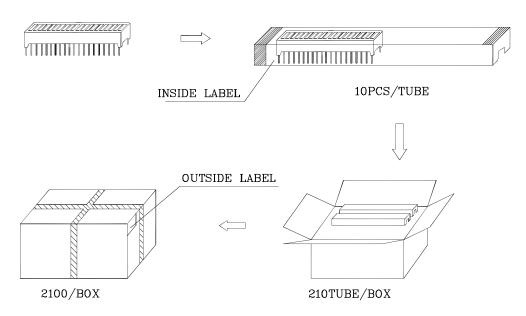
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

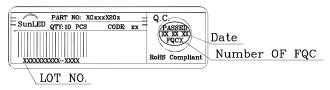




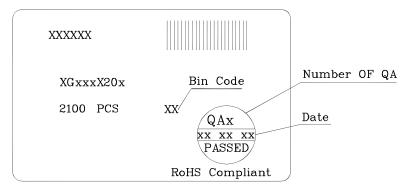
PACKING & LABEL SPECIFICATIONS



Inside Label On IC-tube



Outside Label On Box



TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

Mar 05,2014